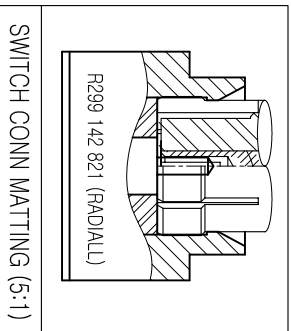
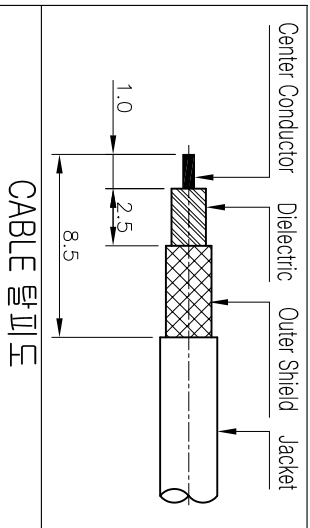
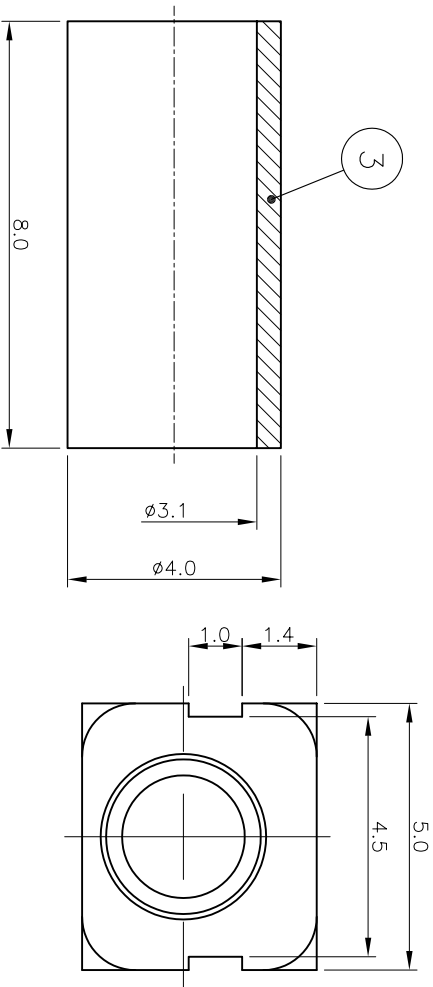
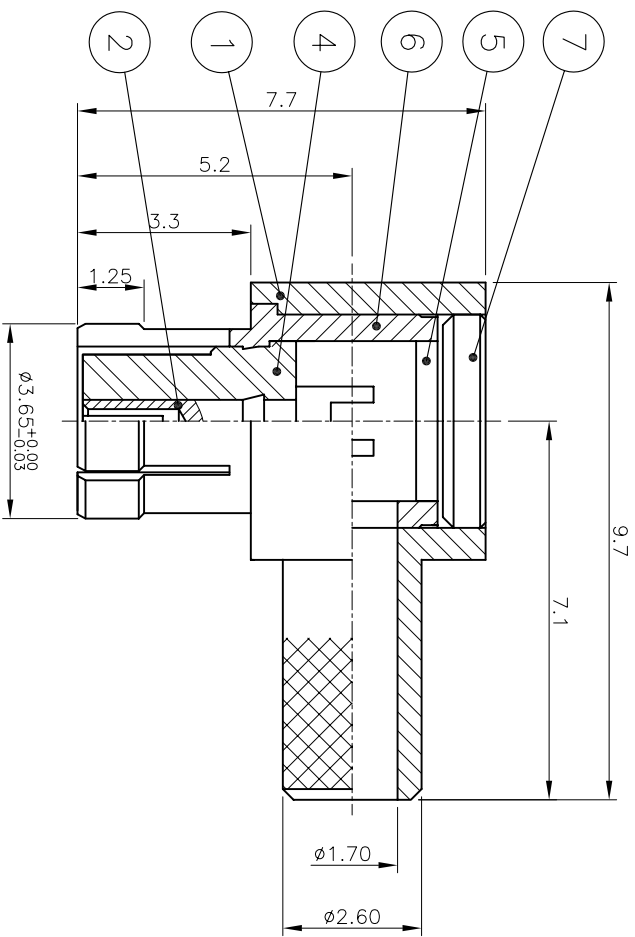


REVISION		
REV	DESCRIPTION	DATE
1	최초 개정	2009. 07. 27.



NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
7	COVER	1	MBSBD	Gold Plate	DC000014-5/1 (LS001)
6	JACK	1	BeCu	Gold Plate	DJA00131-5/1
5	INSULATOR	1	TEFLON	White	DIN00934-N/1 (H1096)
4	INSULATOR	1	TEFLON	White	DIN01590-N/1
3	FERRULE	1	MBSBD	Gold Plate	DFE00027-5/1 (F2006)
2	CONTACT	1	BeCu	Gold Plate	DCT02022-5/1
1	AP2 BODY	1	MBSBD	Gold Plate	DBD02513-5/1

TOLERANCE		Decimal	±0.1
Angle		±1°	
MATERIAL		CHECKED BY	I.C.KIM
FINISH		DRAWN BY	E.H.KIM
SCALE		7/1	mm
DATE		2009. 07. 27.	
APPROVED BY		S.J.YOUN	
TITLE		SW(MCX-TPANS) CABLE PL RG316	
DWG NO.		CN02415-7/1	
REVISION		1	R
SHEET		1	of 1